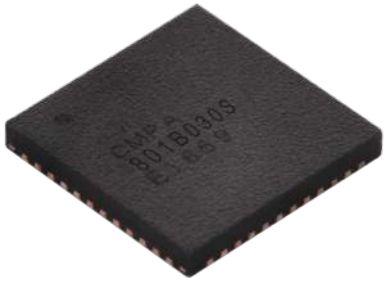
CMPA801B030S

7.9 - 11.0 GHz, 40 W, Packaged GaN MMIC Power Amplifier



Package Type: 7x7 QFN
PN:CMPA801B030S

Description

Wolfspeed's CMPA801B030S is a packaged, 40W HPA utilizing Wolfspeed's high performance, 0.15µm GaN-on-Silicon Carbide production process. The CMPA801B030S operates from 7.9 - 11.0 GHz and targets pulsed radar systems supporting both defense and commercial applications. With 2 stages of gain, this high performance amplifier provides 20dB of large signal gain and 40% efficiency to support lower system DC power requirements and simplify system thermal management solutions. Packaged in a 7x7 mm plastic overmold QFN, the CMPA801B030S also supports reduced board space requirements and high-throughput manufacturing lines.

Typical Performance Over 7.9 - 11.0 GHz (T_C = 25°C)

Parameter	8.0 GHz	8.5 GHz	9.0 GHz	10.0 GHz	11.0 GHz	Units
Small Signal Gain	28.2	27.5	27.1	24.6	24.0	dB
Output Power	39.3	45.9	48.9	42.3	40.7	W
Power Gain	19.9	20.6	21.0	20.3	20.1	dB
Power Added Efficiency	38.2	40.6	41.3	39.4	37.0	%

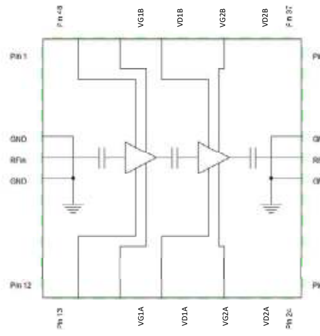
Note: P_{IN} = 26 dBm, Pulse Width = 100µs; Duty Cycle = 10%

Features

- Freq: 7.9 – 11.0 GHz
- P_{SAT}: 40 W
- PAE: 40%
- LS Gain: 20 dB
- 7x7 mm Overmold QFN
- Lower system costs
- Reduced board area

Applications

- Military pulsed radar
- Civil pulsed radar
- Satellite Communications



Note:
Features are typical performance across frequency under 25°C operation.
Please reference performance charts for additional details.

RoHS compliant

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Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V_{DSS}	84	V_{DC}	25˚C
Gate-source Voltage	V_{GS}	-10, +2		
Storage Temperature	T_{STG}	-65, +150	ºC	
Maximum Forward Gate Current	I_G	12	mA	25˚C
Maximum Drain Current	I_{DMAX}	6	A	
Soldering Temperature	T_S	260	ºC	

Electrical Characteristics (Frequency = 7.9 GHz to 11.0 GHz unless otherwise stated; T_C = 25ºC)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics						
Gate Threshold Voltage	$V_{GS(th)}$	-2.6	—	-1.6	V	V_{DS} = 10 V, I_D = 13 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-1.75	–	V_{DC}	V_{DD} = 28 V, I_{DQ} = 800 mA
Saturated Drain Current[1]	I_{DS}	—	4	–	A	V_{DS} = 6.0 V, V_{GS} = 2.0 V
Drain-Source Breakdown Voltage	V_{BD}	84	–	–	V	V_{GS} = -8 V, I_D = 13 mA
RF Characteristics[2,3]						
Small Signal Gain at 8.0 GHz	$S21_1$	–	28.2	–	dB	V_{DD} = 28 V, I_{DQ} = 800 mA
Small Signal Gain at 8.5 GHz	$S21_2$	–	27.5	–		
Small Signal Gain at 9.0 GHz	$S21_3$	–	27.1	–		
Small Signal Gain at 10.0 GHz	$S21_4$	–	24.6	–		
Small Signal Gain at 11.0 GHz	$S21_5$	–	24.0	–		
Output Power at 8.0 GHz	P_{OUT1}	–	39.3	–	W	V_{DD} = 28 V, I_{DQ} = 800 mA, P_{IN} = 26 dBm
Output Power at 8.5 GHz	P_{OUT2}	–	45.9	–		
Output Power at 9.0 GHz	P_{OUT3}	–	48.9	–		
Output Power at 10.0 GHz	P_{OUT4}	–	42.3	–		
Output Power at 11.0 GHz	P_{OUT5}	–	40.7	–		
Power Added Efficiency at 8.0 GHz	PAE_1	–	38	–	%	
Power Added Efficiency at 8.5 GHz	PAE_2	–	41	–		
Power Added Efficiency at 9.0 GHz	PAE_3	–		–		
Power Added Efficiency at 10.0 GHz	PAE_4	–	39	–		
Power Added Efficiency at 11.0 GHz	PAE_5	–	37	–		
Power Gain	G_P	–	21.0	–	dB	V_{DD} = 28 V, I_{DQ} = 800 mA
Input Return Loss	S11	–	-13	–		
Output Return Loss	S12	–	-10	–		
Output Mismatch Stress	VSWR	–	–	5:1	Ψ	No damage at all phase angles, V_{DD} = 28 V, I_{DQ} = 800 mA

Notes:
[1] Scaled from PCM data
[2] All data pulse tested in CMPA801B030S-AMP1
[3] Pulse Width = 100µs; Duty Cycle = 10%

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Thermal Characteristics

Parameter	Symbol	Rating	Units	Conditions
Operating Junction Temperature	T_J	225	°C	
Thermal Resistance, Junction to Case (packaged)[1]	$R_{\theta JC}$	2.5	°C/W	100µs, 10%, P_{DISS} = 25.5 W

Notes:
[1] Measured for the CMPA801B030S at P_{DISS} = 25.5 W

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

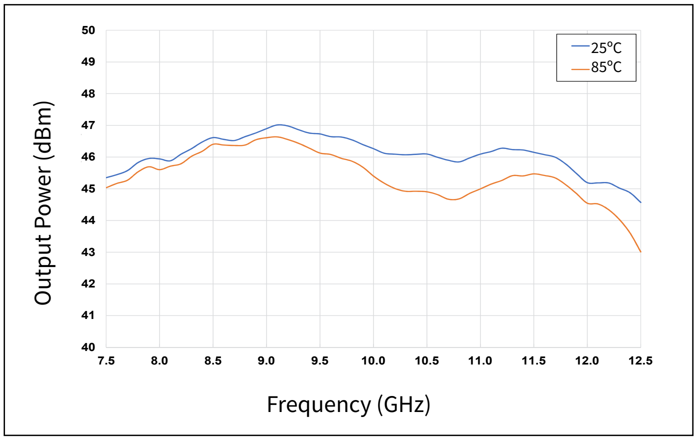

Figure 1. Output Power vs Frequency as a Function of Temperature

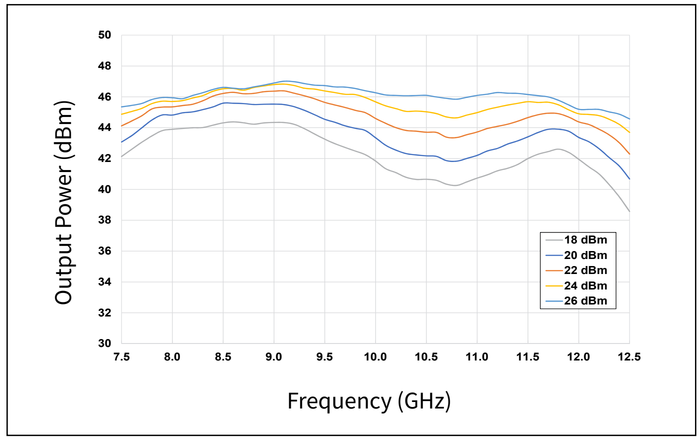

Figure 2. Output Power vs Frequency as a Function of Input Power

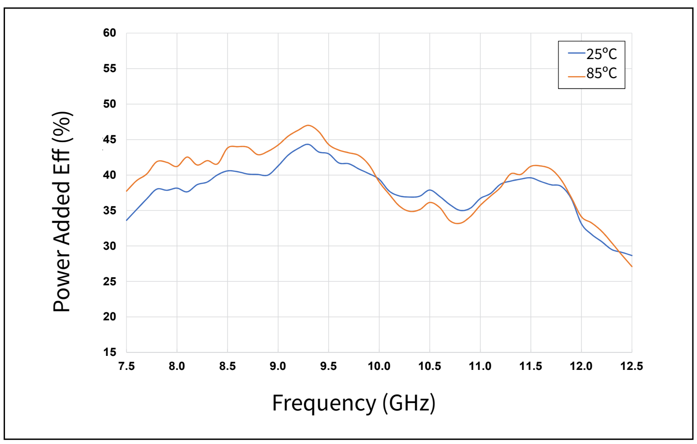

Figure 3. Power Added Eff. vs Frequency as a Function of Temperature

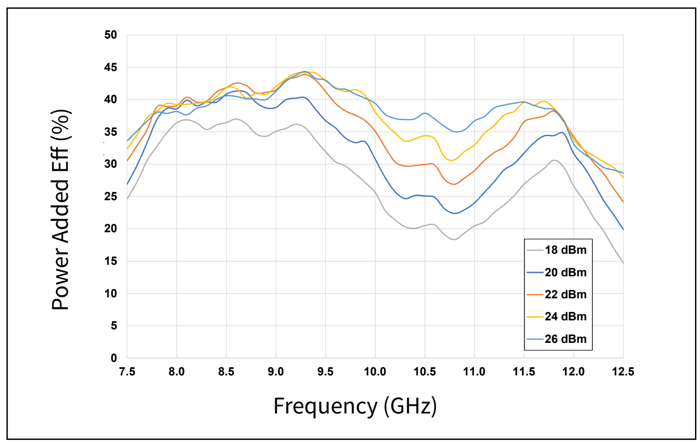

Figure 4. Power Added Eff. vs Frequency as a Function of Input Power

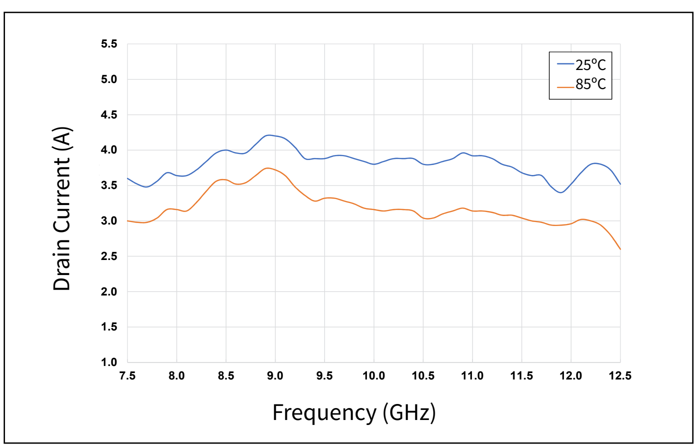

Figure 5. Drain Current vs Frequency as a Function of Temperature

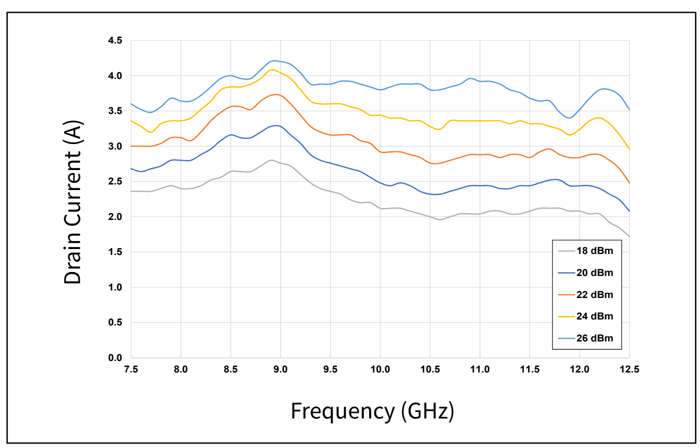

Figure 6. Drain Current vs Frequency as a Function of Input Power

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

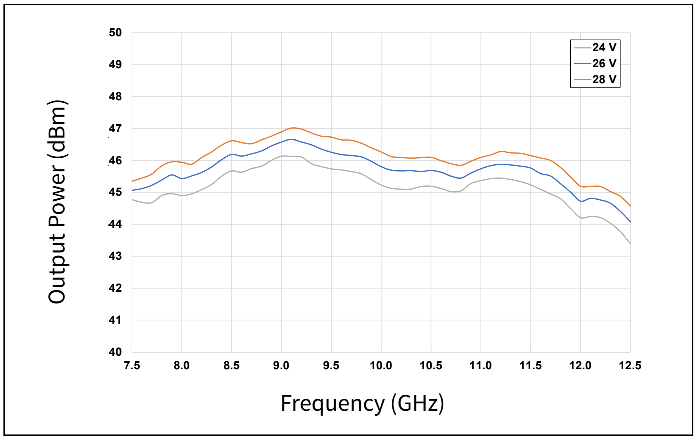

Figure 7. Output Power vs Frequency as a Function of V_D

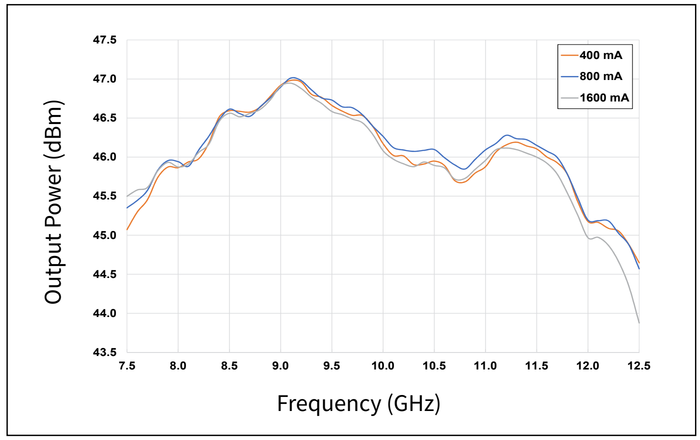

Figure 8. Output Power vs Frequency as a Function of I_{DQ}

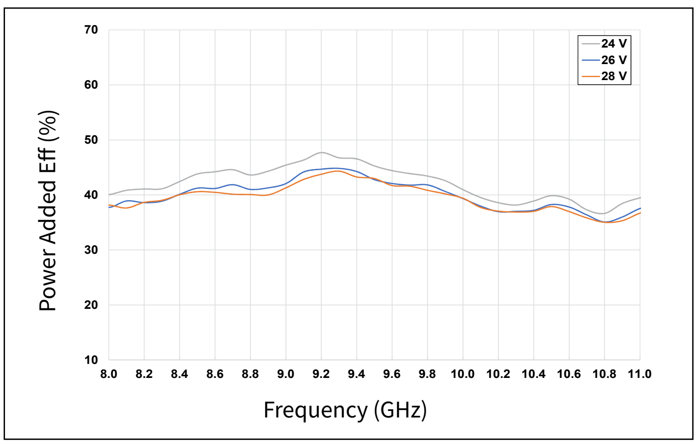

Figure 9. Power Added Eff. vs Frequency as a Function of V_D

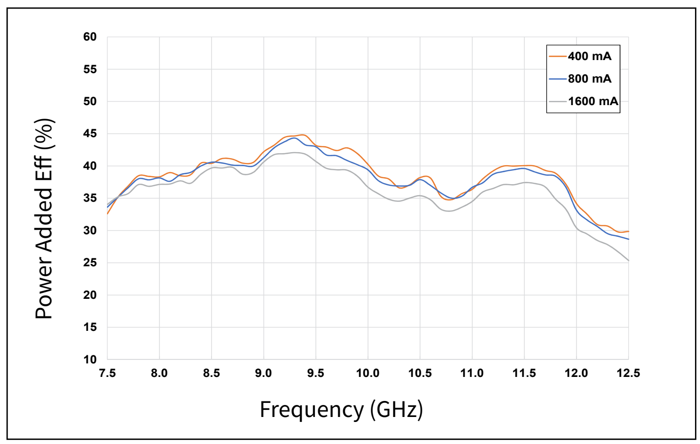

Figure 10. Power Added Eff. vs Frequency as a Function of I_{DQ}

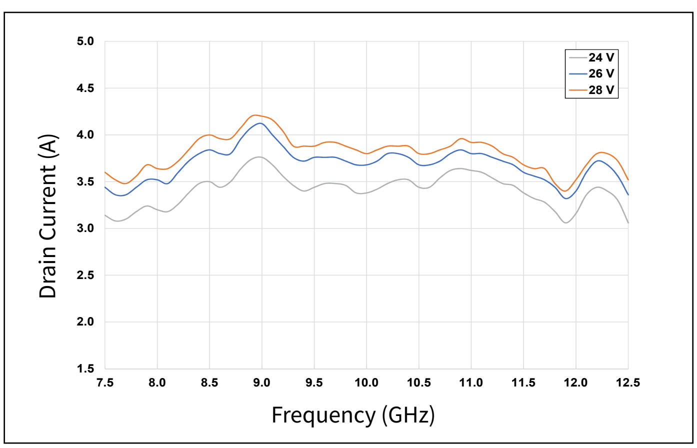

Figure 11. Drain Current vs Frequency as a Function of V_D

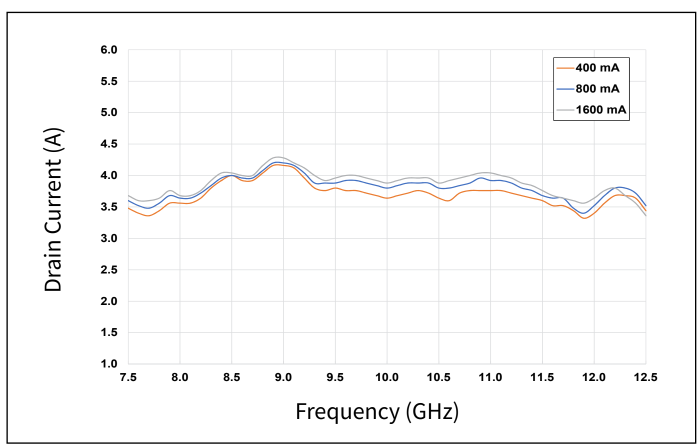

Figure 12. Drain Current vs Frequency as a Function of I_{DQ}

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Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

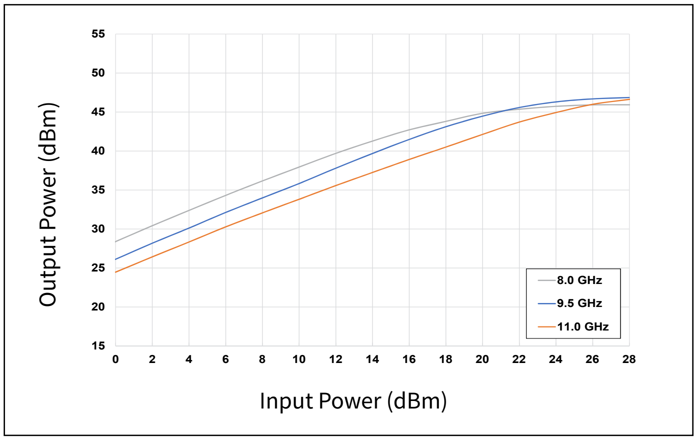


Figure 13. Output Power vs Input Power as a Function of Frequency

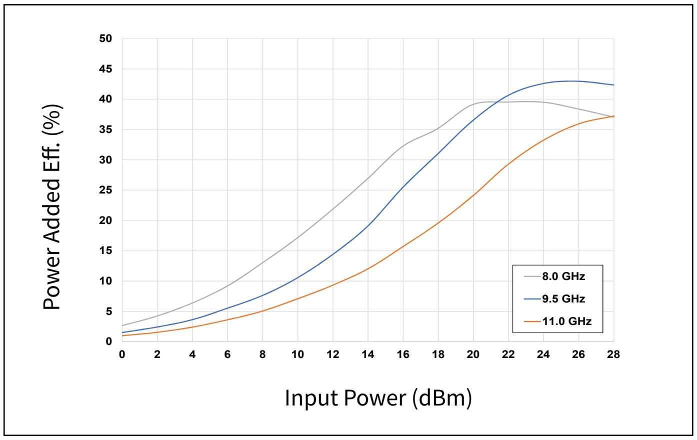


Figure 14. Power Added Eff. vs Input Power as a Function of Frequency

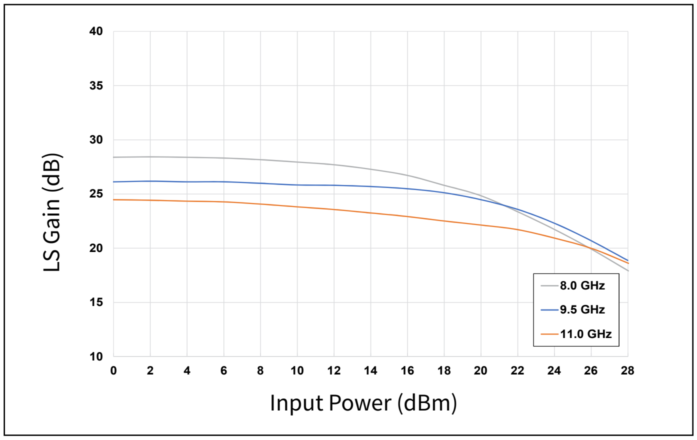


Figure 15. Large Signal Gain vs Input Power as a Function of Frequency

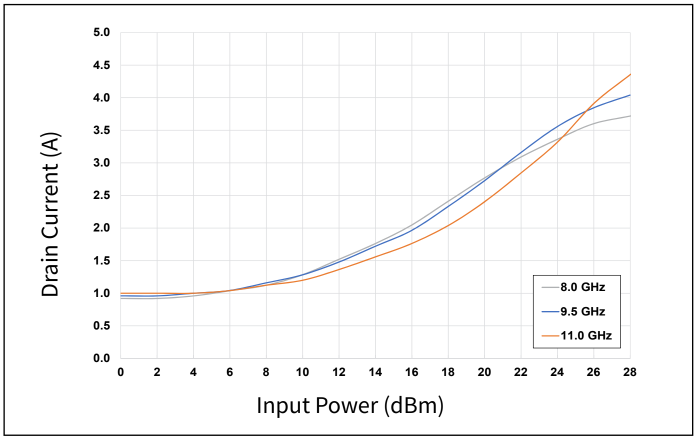


Figure 16. Drain Current vs Input Power as a Function of Frequency

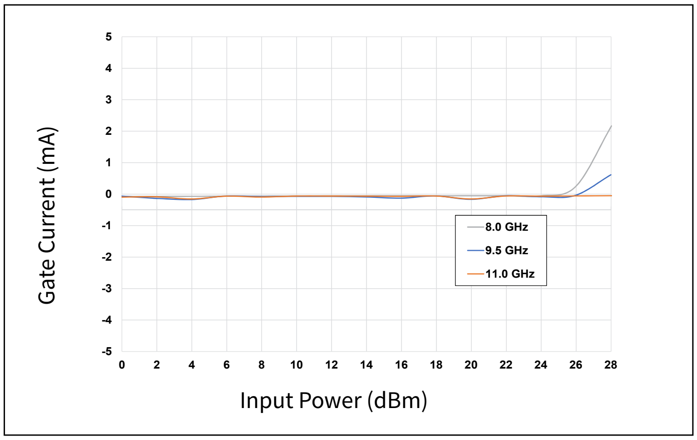


Figure 17. Gate Current vs Input Power as a Function of Frequency

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

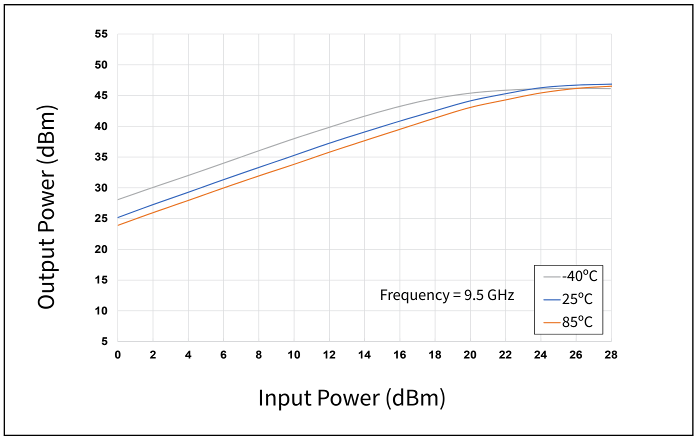


Figure 18. Output Power vs Input Power as a Function of Temperature

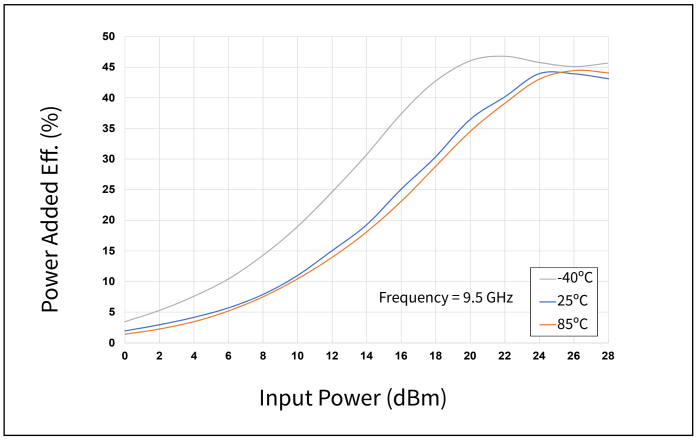


Figure 19. Power Added Eff. vs Input Power as a Function of Temperature

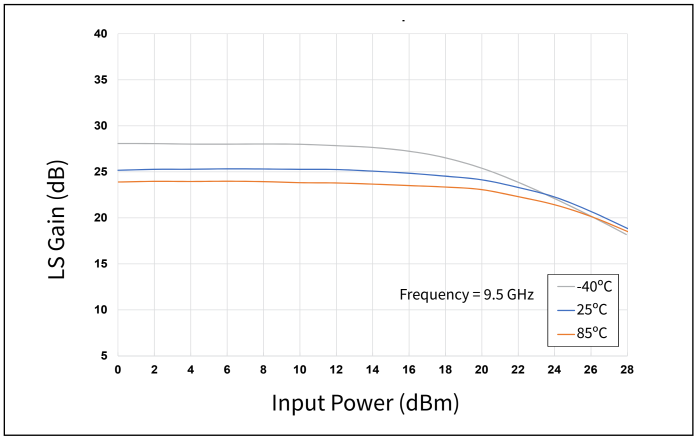


Figure 20. Large Signal Gain vs Input Power as a Function of Temperature

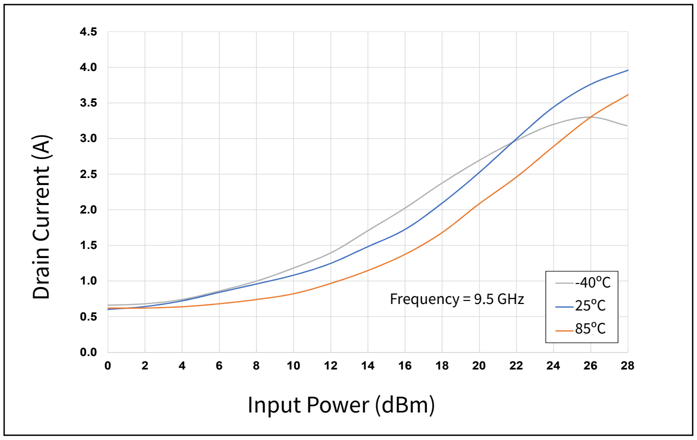


Figure 21. Drain Current vs Input Power as a Function of Temperature

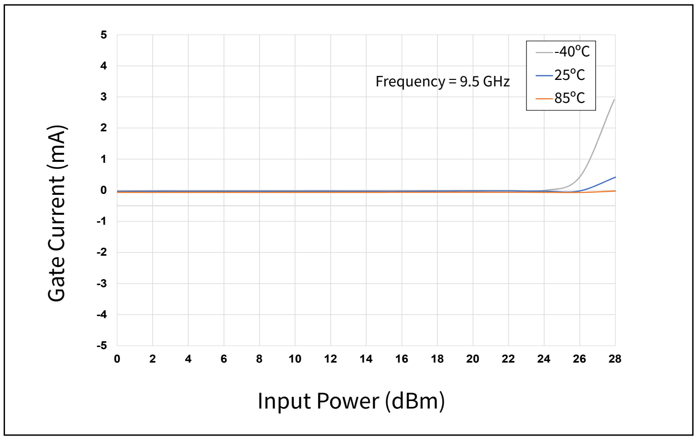


Figure 22. Gate Current vs Input Power as a Function of Temperature

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

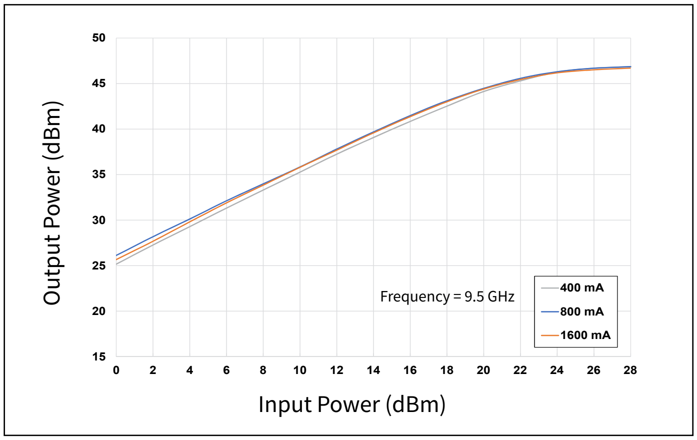


Figure 23. Output Power vs Input Power as a Function of I_{DQ}

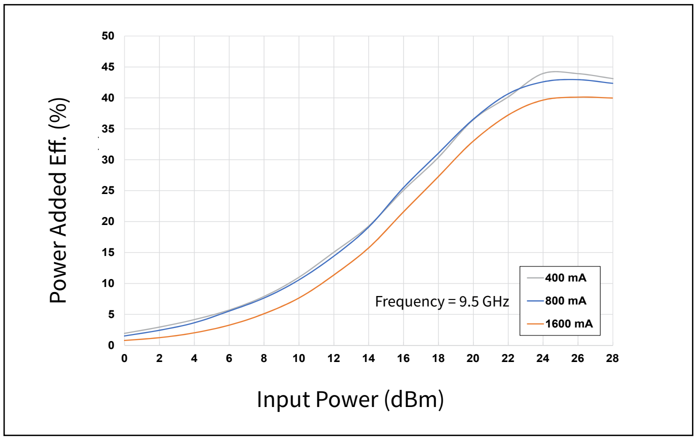


Figure 24. Power Added Eff. vs Input Power as a Function of I_{DQ}

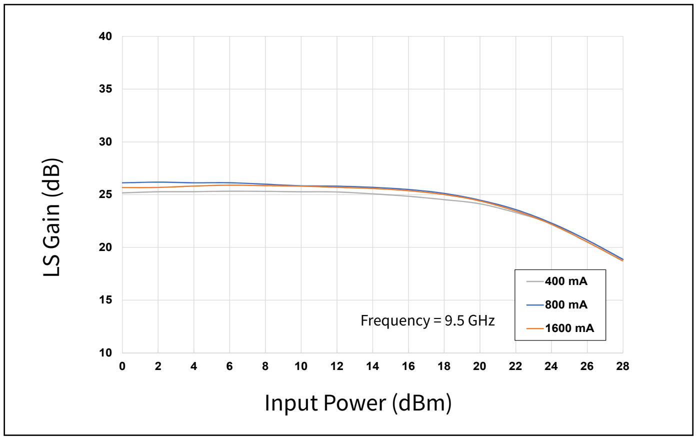


Figure 25. Large Signal Gain vs Input Power as a Function of I_{DQ}

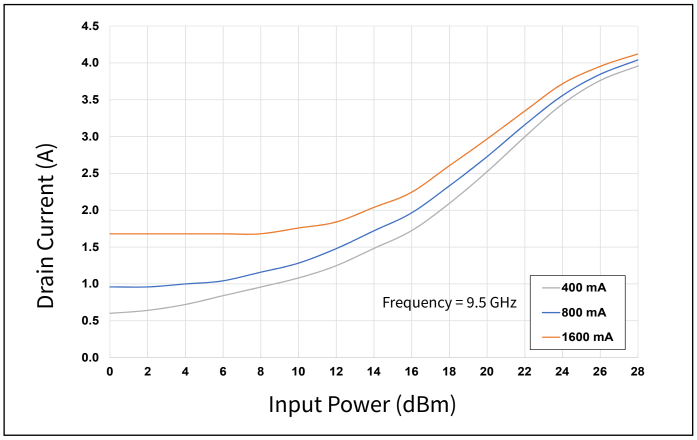


Figure 26. Drain Current vs Input Power as a Function of I_{DQ}

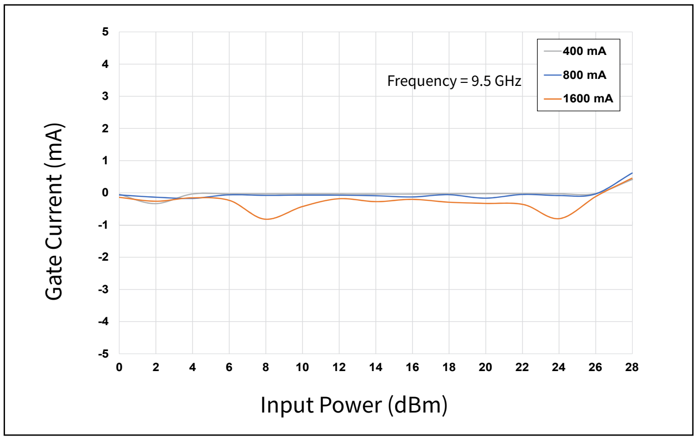


Figure 27. Gate Current vs Input Power as a Function of I_{DQ}

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, PW = 100µs, DC = 10%, P_{IN} = 26 dBm, T_{BASE} = +25°C

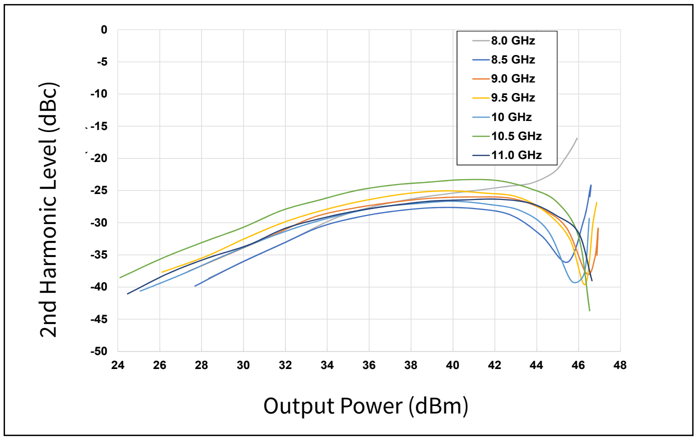


Figure 28. 2nd Harmonic vs Output Power as a Function of Frequency

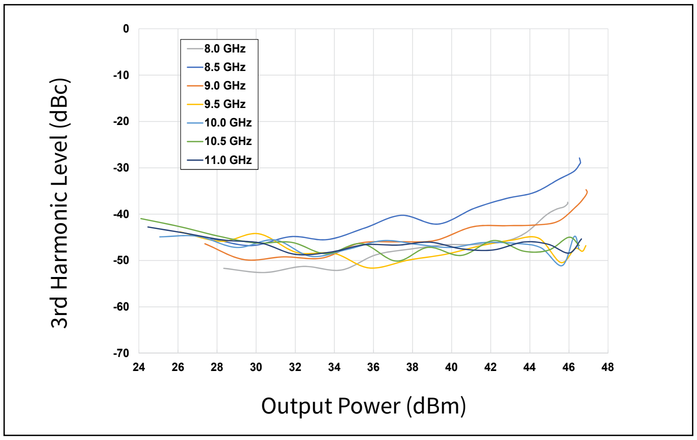


Figure 29. 3rd Harmonic vs Output Power as a Function of Frequency

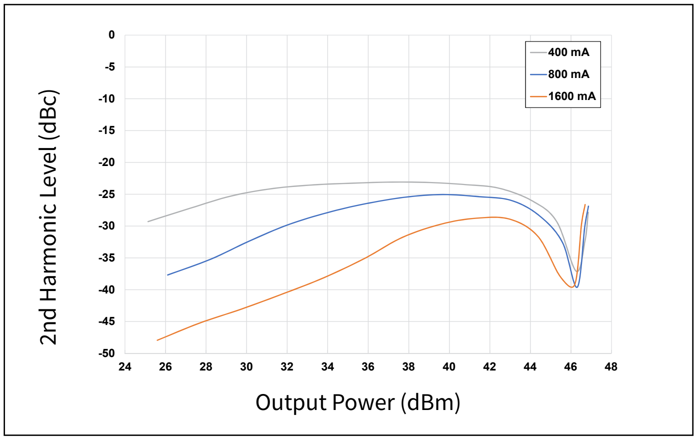


Figure 30. 2nd Harmonic vs Output Power as a Function of I_{DQ}

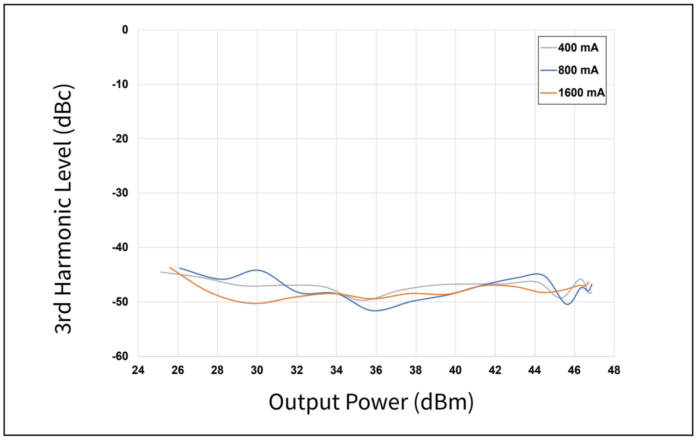


Figure 31. 3rd Harmonic vs Output Power as a Function of I_{DQ}

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, P_{IN} = -20 dBm, T_{BASE} = +25°C

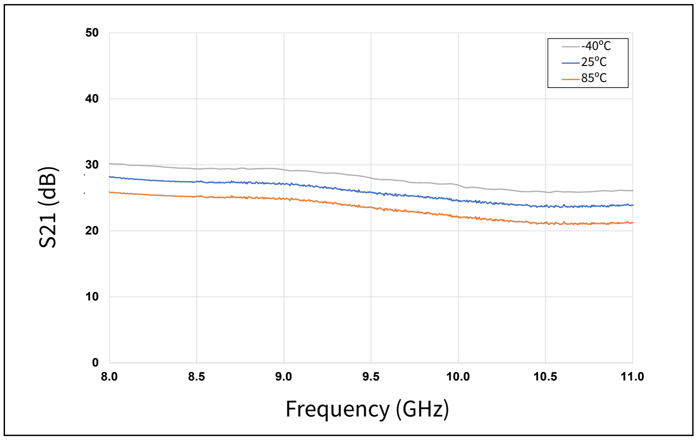


Figure 32. Gain vs Frequency as a Function of Temperature

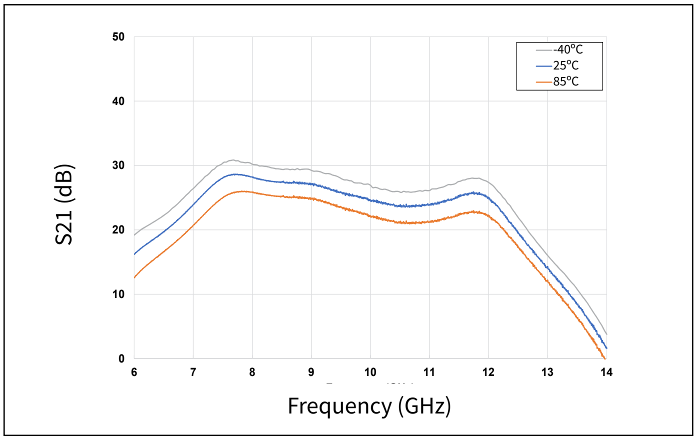


Figure 33. Gain vs Frequency as a Function of Temperature

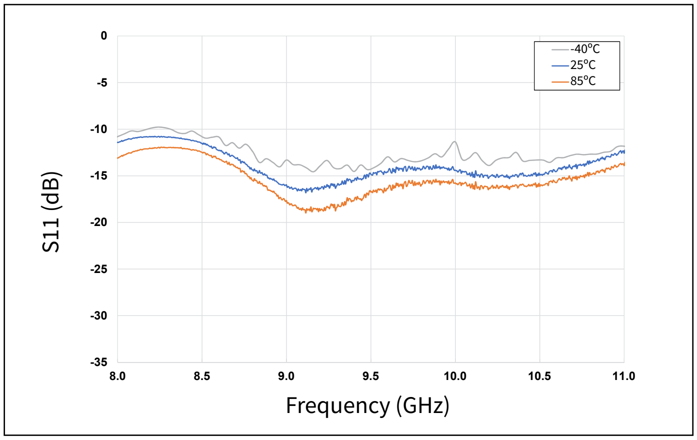


Figure 34. Input RL vs Frequency as a Function of Temperature

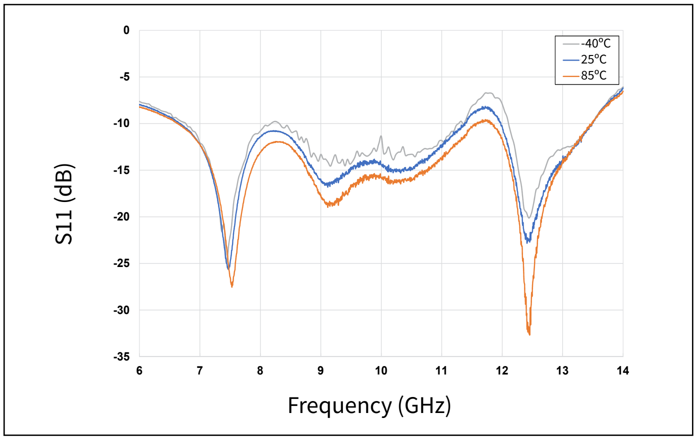


Figure 35. Input RL vs Frequency as a Function of Temperature

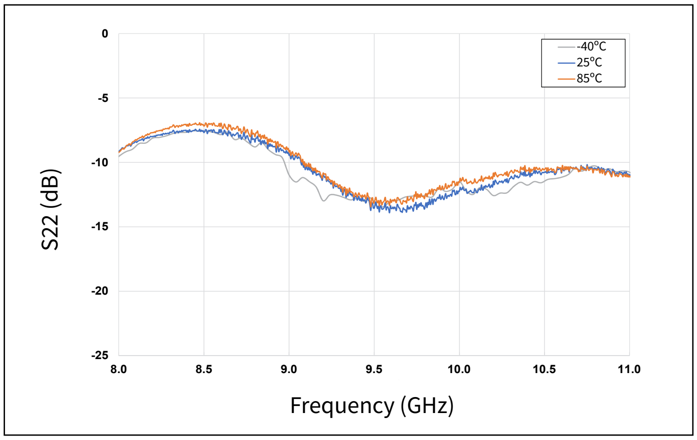


Figure 36. Output RL vs Frequency as a Function of Temperature

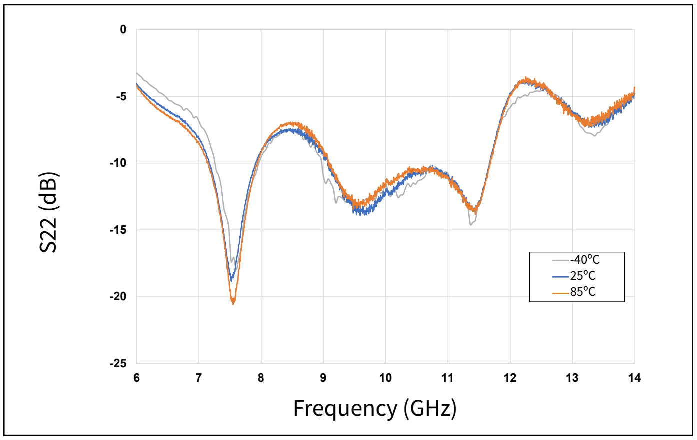


Figure 37. Output RL vs Frequency as a Function of Temperature

Typical Performance of the CMPA801B030S

Test conditions unless otherwise noted: V_D = 28 V, I_{DQ} = 800 mA, P_{IN} = -20 dBm, T_{BASE} = +25°C

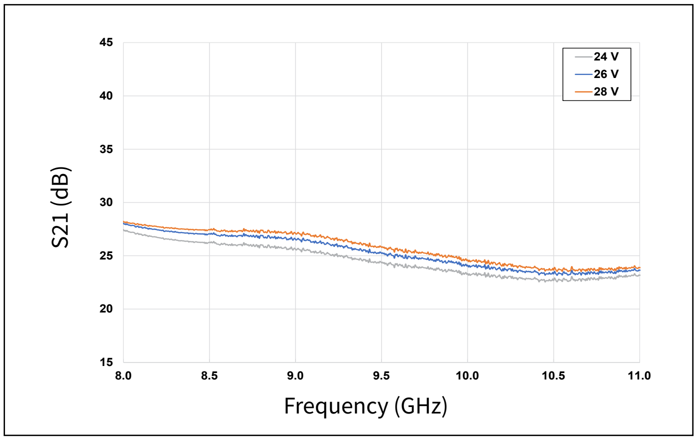


Figure 38. Gain vs Frequency as a Function of Voltage

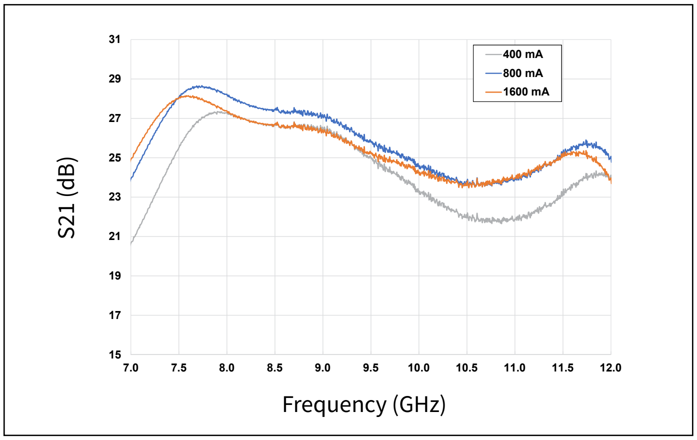


Figure 39. Gain vs Frequency as a Function of I_{DQ}

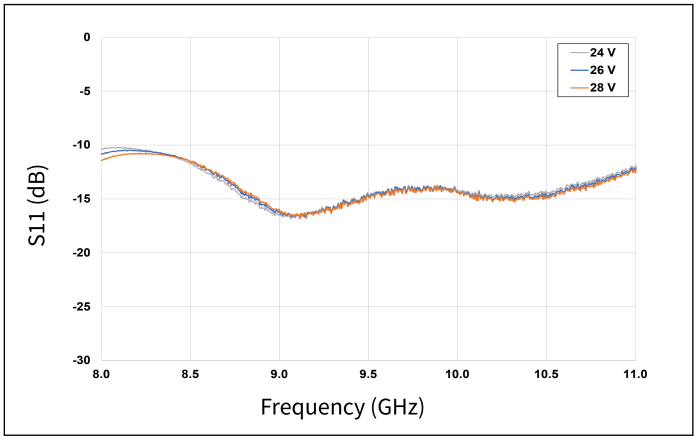


Figure 40. Input RL vs Frequency as a Function Voltage

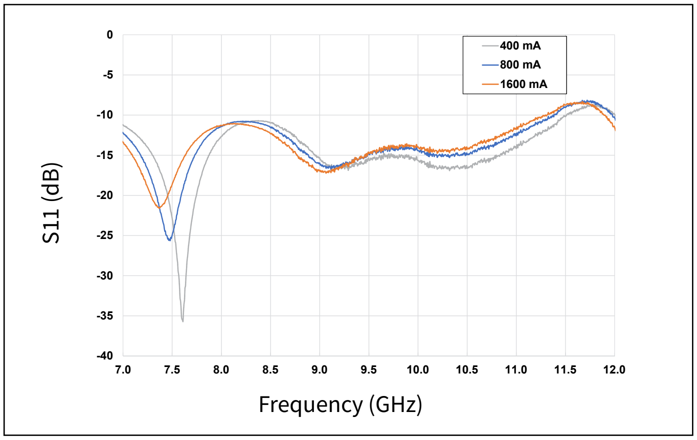


Figure 41. Input RL vs Frequency as a Function of I_{DQ}

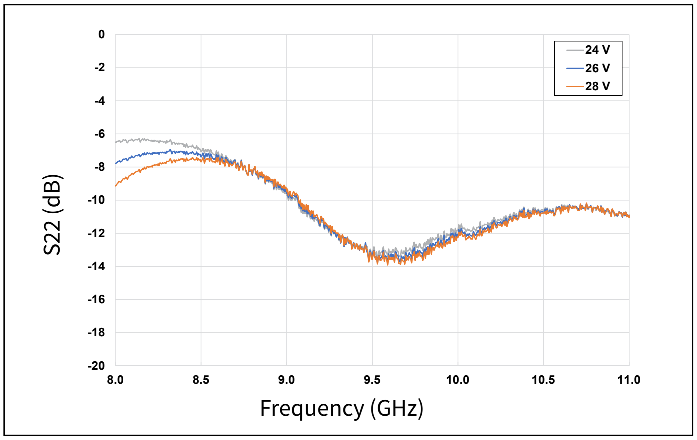


Figure 42. Output RL vs Frequency as a Function of Voltage

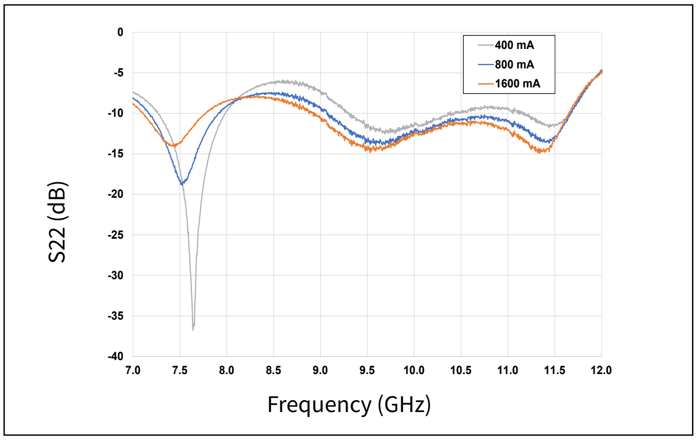
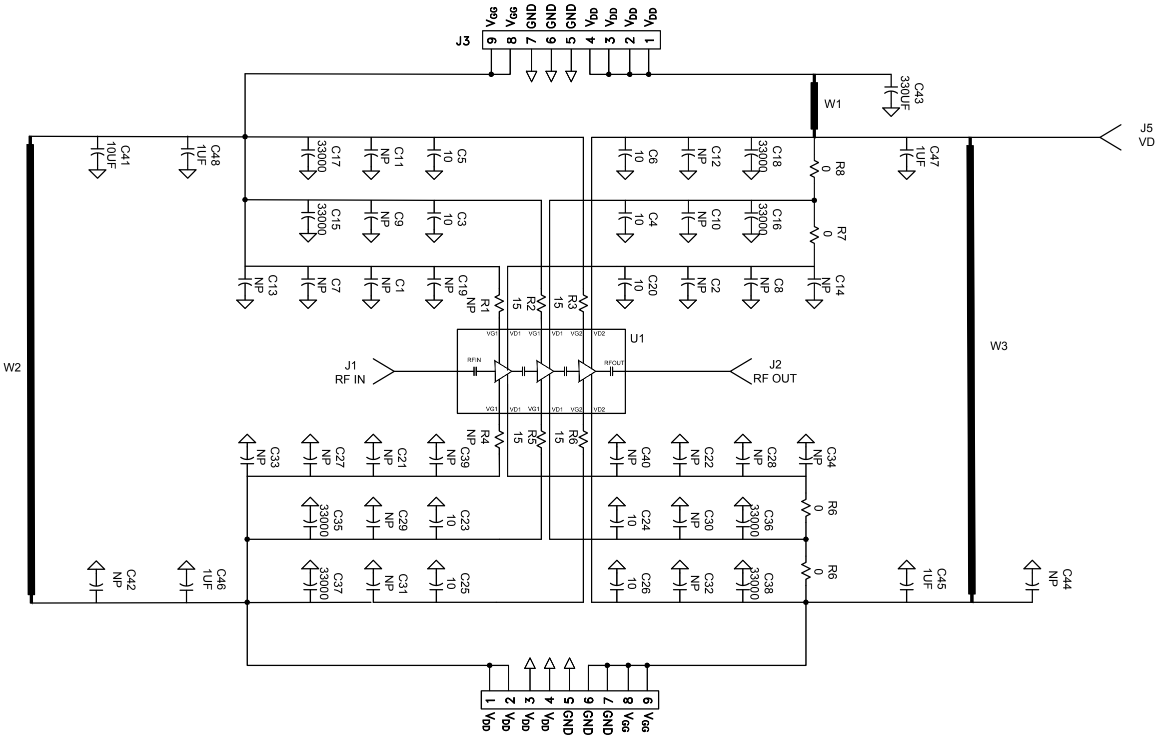
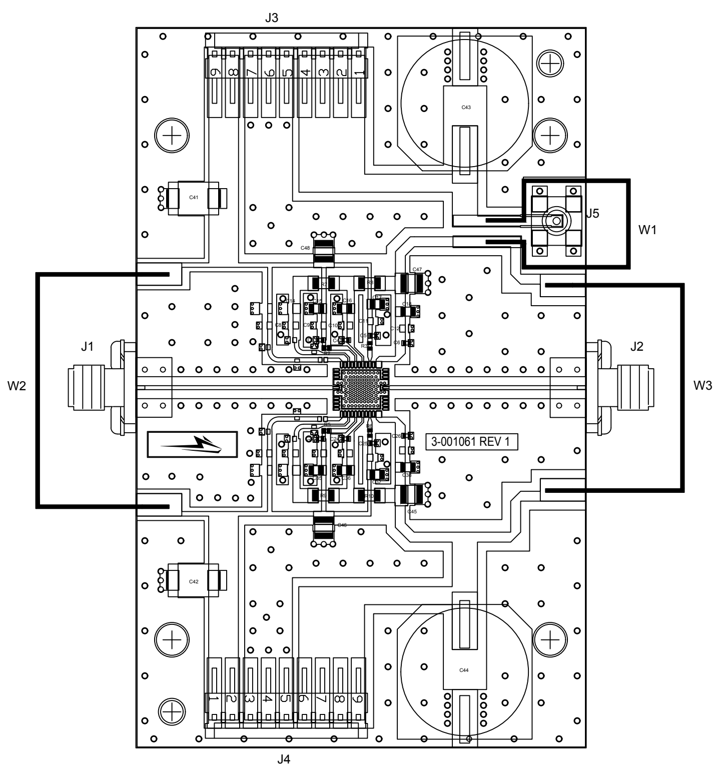


Figure 43. Output RL vs Frequency as a Function of I_{DQ}

CMPA801B030S-AMP1 Application Circuit



CMPA801B030S-AMP1 Evaluation Board Layout



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CMPA801B030S-AMP1 Evaluation Board Bill of Materials

Designator	Description	Qty
C3, C4, C5, C6, C23, C24, C25, C26	CAP, 10pF, +/-5%, pF, 200V, 0402	8
C15, C16, C17, C18, C35, C36, C37, C38	CA, 330000pF, 0805,100V, X7R	8
C45, C46, C47, C48	CAP, 1.0µF, 100V, 10%, X7R, 1210	4
C41	CAP 10µF 16V TANTALUM, 2312	1
C43	CAP, 330µF, +/-20%, 100V, ELECTROLYTIC, CASE SIZE K16	1
R2, R3, R5, R6	RES 15 OHM, +/-1%, 1/16W, 0402	6
R8, R10	RES 0.0 OHM 1/16W 1206 SMD	2
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	4
J5	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3, J4	HEADER RT>PLZ .1CEN LK 9POS	1
W2, W3	WIRE, BLACK, 20 AWG ~ 2.5”	2
W1	WIRE, BLACK, 20 AWG ~ 3.0”	1
	PCB, TEST FIXTURE, RF-35TC, 0.010 THK, 7X7 Overmold QFN SOCKET BOARD	1
	2-56 SOC HD SCREW 3/16 SS	4
	#2 SPLIT LOCKWASHER SS	4
Q1	CMPA801B030S	1

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	1A	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	C2B	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C

Moisture Sensitivity Level (MSL) Classification

Parameter	Symbol	Level	Test Methodology
Moisture Sensitivity Level	MSL	3 (168 hours)	IPC/JEDEC J-STD-20

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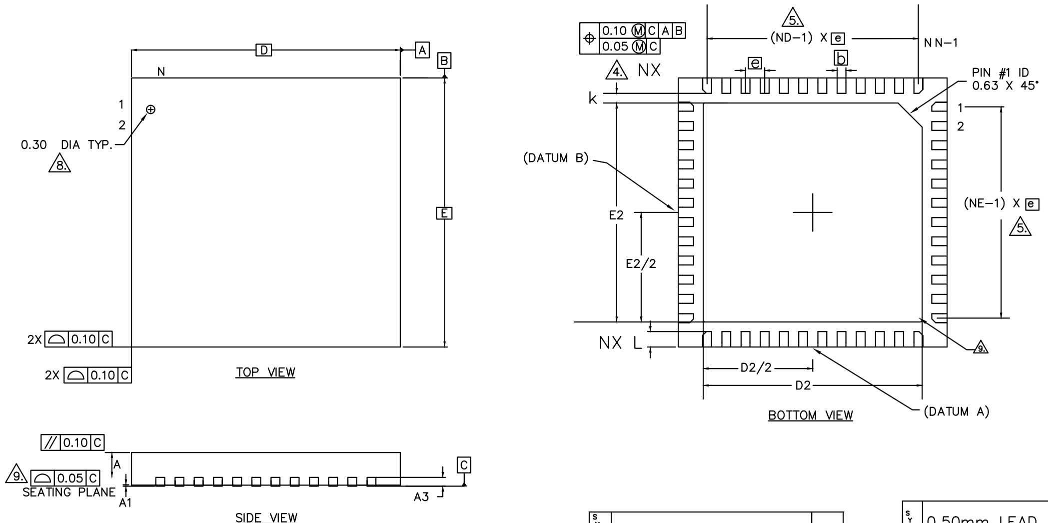
Product Dimensions CMPA801B030S (Package Type — 7x7 QFN)

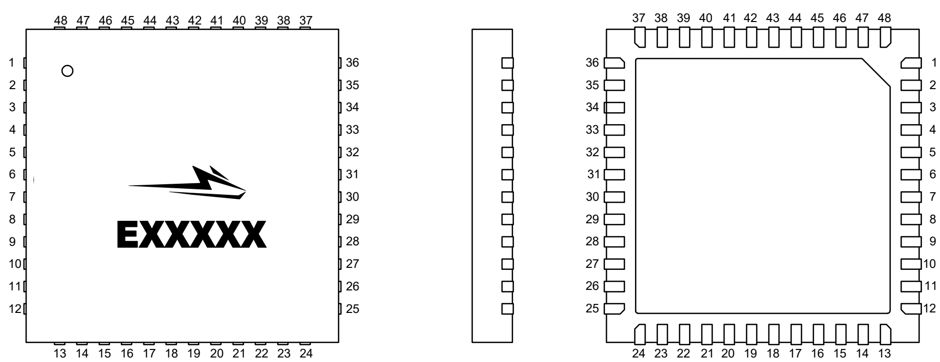


NOTES :

1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M. – 1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS, θ IS IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL TIP.
5. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
6. MAX. PACKAGE WARPAGE IS 0.05 mm.
7. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
8. PIN #1 ID ON TOP WILL BE LASER MARKED.
9. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
10. THIS DRAWING CONFORMS TO JEDEC REGISTERED OUTLINE MO-220
11. ALL PLATED SURFACES ARE TIN 0.010 mm +/− 0.005mm.

SYMBOL	MIN.	NOM.	MAX.	NOTE
A	0.80	0.9	1.0	
A1	0.00	0.03	0.06	
A3		0.20 REF.		
θ	0	—	12	2
K		0.20 MIN.		
D		7.0 BSC		
E		7.0 BSC		

SYMBOL	0.50mm LEAD PITCH			NOTE
	MIN.	NOM.	MAX.	
e		0.50 BSC.		
N		48		3
ND		12		5
NE		12		5
L	0.35	0.41	0.46	
b	0.19	0.25	0.33	4
D2	5.61	5.72	5.83	
E2	5.61	5.72	5.83	



PIN	DESC.	PIN	DESC.	PIN	DESC.	PIN	DESC.
1	NC	15	NC	29	NC	43	NC
2	NC	16	NC	30	RFGND	44	VG1B
3	NC	17	VG1A	31	RFOUT	45	NC
4	NC	18	NC	32	RFGND	46	NC
5	RFGND	19	VD1A	33	NC	47	NC
6	RFIN	20	NC	34	NC	48	NC
7	RFGND	21	VG2A	35	NC		
8	NC	22	NC	36	NC		
9	NC	23	VD2A	37	NC		
10	NC	24	NC	38	VD2B		
11	NC	25	NC	39	NC		
12	NC	26	NC	40	VG2B		
13	NC	27	NC	41	NC		
14	NC	28	NC	42	VD1B		

Part Number System

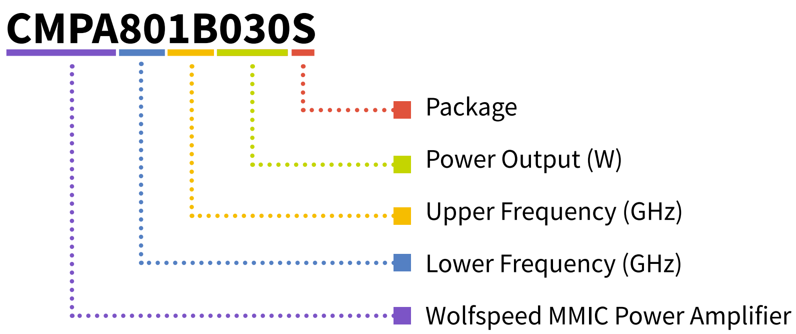


Table 1.

Parameter	Value	Units
Lower Frequency	7.9	GHz
Upper Frequency	11.0	
Power Output	40	W
Package	Surface Mount	–

Note:
[1] Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples	1A = 10.0 GHz 2H = 27.0 GHz

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Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA801B030S	Packaged GaN MMIC PA	Each	
CMPA801B030S-AMP1	Evaluation Board with GaN MMIC Installed	Each	

For more information, please contact:

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